

CyberOptics LSM2 Laser Profilometer

DESCRIPTION:

- SMT inspection system for non-contact measurement of critical printing parameters

- Applications

 - Solder pastes

 - Stencil apertures

 - Solder joints

 - Component placement accuracy

- Specifications

 - Maximum object thickness: 5 cm

 - Maximum differential (high magnification)

 - Z: 1440 μm , X: 2473 μm , Y: 1877 μm

 - Work-surface(W x L): 36 cm x 61 cm

 - Throat Depth: 406 mm

 - Operating Temperature: 5 to 40 °C (40 to 100 °F).

 - Ambient Operating Humidity: <90% (non-condensing)



LOCATION: PROCESS DESIGN AND ANALYSIS LABORATORY, ROOM B7

[CONTACT US](#)

CONTACTS

For more information or to arrange for the use of this equipment, contact any of the IEEC staff members listed below:

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